

# DELO DUALBOND<sup>®</sup> BS3770

**modified polycarbamin acid derivate | 1C | light-fixable / heat-curing**

free of solvents | thixotropic | light-fixable, heat curing mandatory, tension-equalizing

### Special features of product

- compliant with RoHS Directive 2015/863/EU
- halogen-free according to IEC 61249-2-21

### Function

- B stage adhesive
- die attach adhesive
- electronic adhesive

### Typical area of use

- -40 - 150 °C

### Curing

Suitable lamp types LED 365 nm, LED 400 nm

Typical irradiation time

*intensity 200 mW/cm<sup>2</sup>  
LED 400 nm  
A stage to B stage* 10 s

Typical curing time

*at +150 °C  
in air convection oven  
B stage to C stage* 40 min

### Processing

Typical adhesive application needle dispensing, stencil printing, screen printing

Conditioning time (typical)

*when stored in cold conditions  
in containers up to 10 ml* 0.5 h

Processing time A stage

*in standard climate +23 °C / 50 % r. h.  
in containers up to 10 ml* 3 d

Processing time B stage

*in standard climate +23 °C / 50 % r. h.* 21 d

Storage life in unopened original container

*at -18 °C* 6 month(s)

**Technical properties**

Color in uncured condition beige

Color in cured condition in 1 mm layer thickness beige

Transparency in cured condition in 1 mm layer thickness opaque

**Parameters**

Density 1 g/cm<sup>3</sup>  
*DELO Standard 13 | 150 °C | 40 min*

Viscosity 115000 mPa·s  
*liquid | Rheometer | Shear rate: 10 1/s | Gap: 500 µm*

Thixotropy index 3.2  
*liquid | Rheometer | Gap: 500 µm*

Die shear strength 18 N  
*DELO Standard 30 | **Si** | Chip 2 mm x 2 mm | **Ag** | 150 °C | 40 min*

Die shear strength 15 N  
*DELO Standard 30 | **Si** | Chip 2 mm x 2 mm | **Solder resist** | 50 mm x 25 mm | Pretreatment: Annealing | 400 nm | 200 mW/cm<sup>2</sup> | 10 s | Plus | 150 °C | 40 min*

Die shear strength 18 N  
*DELO Standard 30 | **Si** | Chip 2 mm x 2 mm | **Solder resist** | 50 mm x 25 mm | Pretreatment: Annealing | 150 °C | 40 min*

Tensile strength 2 MPa  
*by the criteria of DIN EN ISO 527 | 150 °C | 40 min*

Elongation at tear 200 %  
*by the criteria of DIN EN ISO 527 | 150 °C | 40 min*

Young's modulus 2 MPa  
*Rheometer | 400 nm | 200 mW/cm<sup>2</sup> | 10 s | Plus | 150 °C | 40 min*

Young's modulus <i>DELO Standard 54   Rheometer   150 °C   40 min</i>	5	MPa
Shore hardness A <i>by the criteria of DIN EN ISO 868   150 °C   40 min</i>	37	
Glass transition temperature <i>DELO Standard 54   Rheometer   150 °C   40 min</i>	-57	°C
Coefficient of linear expansion <i>DELO Standard 26   TMA   Evaluation T: -97 °C - -91 °C   150 °C   40 min</i>	83	ppm/K
Coefficient of linear expansion <i>DELO Standard 26   TMA   Evaluation T: 31 °C - 42 °C   150 °C   40 min</i>	253	ppm/K
Shrinkage <i>150 °C   40 min</i>	0.38	vol. %

**Converting table**

°F = (°C x 1.8) + 32	1 MPa = 145.04 psi
1 inch = 25.4 mm	1 GPa = 145.04 ksi
1 mil = 25.4 µm	1 cP = 1 mPa·s
1 oz = 28.3495 g	1 N = 0.225 lb

**General curing and processing information**

The curing time stated in the technical data was determined in the laboratory. It can vary depending on the adhesive quantity and component geometry and is therefore a reference value. The heating time of the components must be added to the actual curing time. It depends on component size and type of heat input. The specified curing temperature must be reached directly at the adhesive. Increasing or decreasing the curing temperature and / or irradiation intensity and / or irradiation time shortens or prolongs the curing time and can lead to changed physical properties. Only a small part of the bonding should be light-fixed as the maximum build-up of adhesion is achieved by pure heat curing. The adhesive shows postcuring behavior. After heat curing at low temperatures and a short curing time, a certain level of strength is already achieved. The adhesive postcures at room temperature and achieves a level of strength corresponding to the curing temperature after approx. 24 hours. Depending on the adhesive quantity used, exothermic reaction heat is generated which can lead to overheating. In this case, a lower curing temperature is to be selected. All curing or light fixation parameters depend on material thickness and absorption, adhesive layer thickness, lamp type and distance between lamp and adhesive layer. Optional pre-fixation is performed with light. Heat curing is mandatory. Values measured after 24 h at approx. 23 °C / 50 % r.h., unless otherwise specified.

**General**

The data and information provided are based on tests performed under laboratory conditions. Reliable information about the behavior of the product under practical conditions and its suitability for a specific purpose cannot be concluded from this. It is the customer's responsibility to test the suitability of a product for the intended purpose by considering all specific requirements and by applying standards the customer

deems suitable (e. g. DIN 2304-1). Type, physical and chemical properties of the materials to be processed with the product, as well as all actual influences occurring during transport, storage, processing and use, may cause deviations in the behavior of the product compared to its behavior under laboratory conditions. All data provided are typical average values or uniquely determined parameters measured under laboratory conditions. The data and information provided are therefore no guarantee for specific product properties or the suitability of the product for a specific purpose.

Nothing contained herein shall be construed to indicate the non-existence of any relevant patents or to constitute a permission, encouragement or recommendation to practice any development covered by any patents, without permission of the owner of this patent.

All products provided by DELO are subject to DELO's General Terms of Business. Verbal ancillary agreements are deemed not to exist.

### **Instructions for use**

You can find further details in the instructions for use.

The instructions for use are available on [www.DELO-adhesives.com](http://www.DELO-adhesives.com).

We will be pleased to send them to you on demand.

### **Occupational health and safety**

See material safety data sheet.

### **Specification**

Nothing contained in this Technical Datasheet shall be interpreted as any express warranty or guarantee. This Technical Datasheet is for reference only and does not constitute a product specification. Please ask our responsible Sales Engineer for the applicable product specification which includes defined ranges. DELO is neither liable for any values and content of this Technical Datasheet nor for oral or written recommendations regarding the use, unless otherwise agreed in writing. This limitation of liability is not applicable for damages resulting from intent, gross negligence or culpable breach of cardinal obligations, nor shall it apply in case of death or personal injury or in case of liability under any applicable compulsory law.

## **CONTACT**

DELO DUALBOND BS3770 | as of 20.01.2022 08:08 | Page 4 of 4

**DELO** Industrial Adhesives  
Headquarters

▶ Germany · Windach / Munich ... [www.DELO-adhesives.com](http://www.DELO-adhesives.com)

ADHESIVES

DISPENSING

CURING

CONSULTING

**DELO**